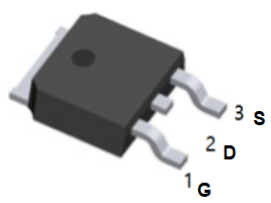
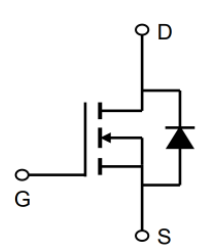


100V N-Channel Enhancement Mode MOSFET

| | |
|---|--|
| <p>Description</p> <p>The STD15NF10 uses advanced trench technology to provide excellent RDS(ON), low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.</p> <p>General Fea</p> <p>$V_{DS} = 100V$ $I_D = 20A$ $R_{DS(ON)} < 75m\Omega @ V_{GS}=10V$</p> <p>Application</p> <p>Battery protection Load switch Uninterruptible power supply</p> |  <p>TO-252(DPAK) top view</p>  |
|---|--|

Absolute Maximum Ratings $T_c=25^\circ C$ unless otherwise noted

| Symbol | Parameter | Rating | Units |
|-----------------------|--|------------|--------------|
| V_{DS} | Drain-Source Voltage | 100 | V |
| V_{GS} | Gate-Source Voltage | ± 20 | V |
| $I_D@T_c=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 20 | A |
| $I_D@T_c=100^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 10 | A |
| $I_D@T_A=25^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 5 | A |
| $I_D@T_A=70^\circ C$ | Continuous Drain Current, $V_{GS} @ 10V^1$ | 3.4 | A |
| I_{DM} | Pulsed Drain Current ² | 30 | A |
| EAS | Single Pulse Avalanche Energy ³ | 36.5 | mJ |
| I_{AS} | Avalanche Current | 15 | A |
| $P_D@T_c=25^\circ C$ | Total Power Dissipation ⁴ | 34.7 | W |
| $P_D@T_A=25^\circ C$ | Total Power Dissipation ⁴ | 2 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | $^\circ C$ |
| T_J | Operating Junction Temperature Range | -55 to 150 | $^\circ C$ |
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient ¹ | 62 | $^\circ C/W$ |
| $R_{\theta JC}$ | Thermal Resistance Junction-Case ¹ | 2.4 | $^\circ C/W$ |

100V N-Channel Enhancement Mode MOSFET

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|------------------------------|--|---|------|-------|------|-------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$ | 100 | --- | --- | V |
| $\Delta BV_{DSS}/\Delta T_J$ | BVDSS Temperature Coefficient | Reference to 25°C, $I_D=1mA$ | --- | 0.098 | --- | V/°C |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance ² | $V_{GS}=10V, I_D=20A$ | --- | 65 | 75 | mΩ |
| | | $V_{GS}=4.5V, I_D=15A$ | --- | 85 | 90 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | | 1.0 | --- | 2.5 | V |
| $\Delta V_{GS(th)}$ | $V_{GS(th)}$ Temperature Coefficient | $V_{GS}=V_{DS}, I_D=250\mu A$ | --- | -4.75 | --- | mV/°C |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=80V, V_{GS}=0V, T_J=25^\circ C$ | --- | --- | 10 | uA |
| | | $V_{DS}=80V, V_{GS}=0V, T_J=55^\circ C$ | --- | --- | 100 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 20V, V_{DS}=0V$ | --- | --- | ±100 | nA |
| g_{fs} | Forward Transconductance | $V_{DS}=5V, I_D=20A$ | --- | 28.7 | --- | S |
| R_g | Gate Resistance | $V_{DS}=0V, V_{GS}=0V, f=1MHz$ | --- | 1.6 | 3.2 | Ω |
| Q_g | Total Gate Charge (10V) | | --- | 26.2 | --- | nC |
| Q_{gs} | Gate-Source Charge | $V_{DS}=80V, V_{GS}=10V, I_D=20A$ | --- | 4.6 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 5.1 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time | | --- | 4.2 | --- | ns |
| T_r | Rise Time | $V_{DD}=50V, V_{GS}=10V, R_G=3.3\Omega$ | --- | 8.2 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time | $I_D=20A$ | --- | 35.6 | --- | |
| T_f | Fall Time | | --- | 9.6 | --- | |
| C_{iss} | Input Capacitance | | --- | 1535 | --- | pF |
| C_{oss} | Output Capacitance | $V_{DS}=15V, V_{GS}=0V, f=1MHz$ | --- | 60 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 37 | --- | |
| I_S | Continuous Source Current ^{1,5} | | --- | --- | 22 | A |
| I_{SM} | Pulsed Source Current ^{2,5} | $V_G=V_D=0V$, Force Current | --- | --- | 45 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{GS}=0V, I_S=1A, T_J=25^\circ C$ | --- | --- | 1.2 | V |
| t_{rr} | Reverse Recovery Time | $I_F=20A, dI/dt=100A/\mu s, T_J=25^\circ C$ | --- | 30 | --- | nS |
| Q_{rr} | Reverse Recovery Charge | | --- | 37 | --- | nC |

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating. The test condition is $V_{DD}=25V, V_{GS}=10V, L=0.1mH, I_{AS}=27A$
4. The power dissipation is limited by 150°C junction temperature
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

Typical Characteristics

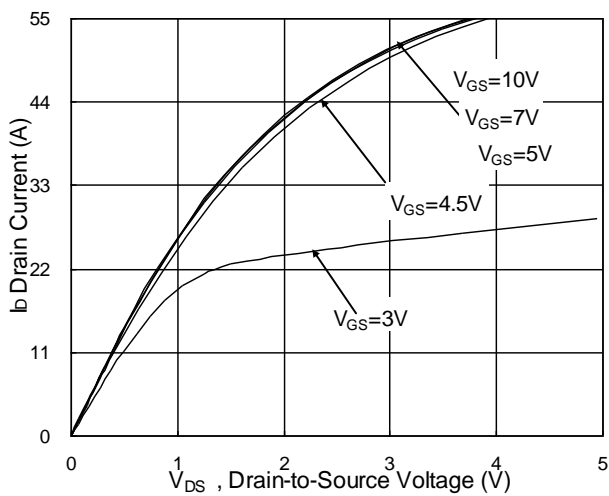


Fig.1 Typical Output Characteristics

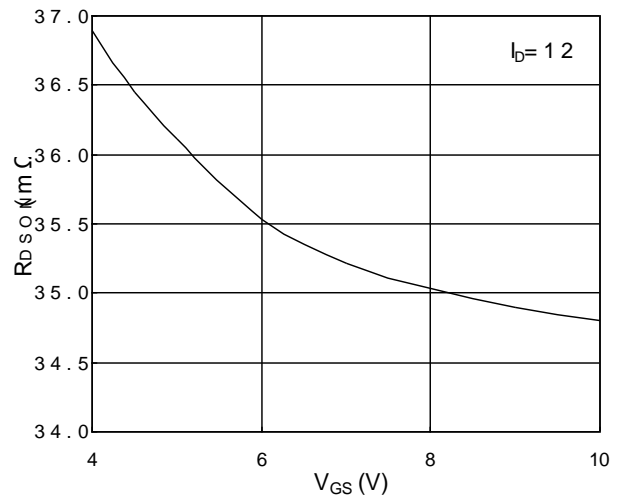


Fig.2 On-Resistance vs. Gate-Source

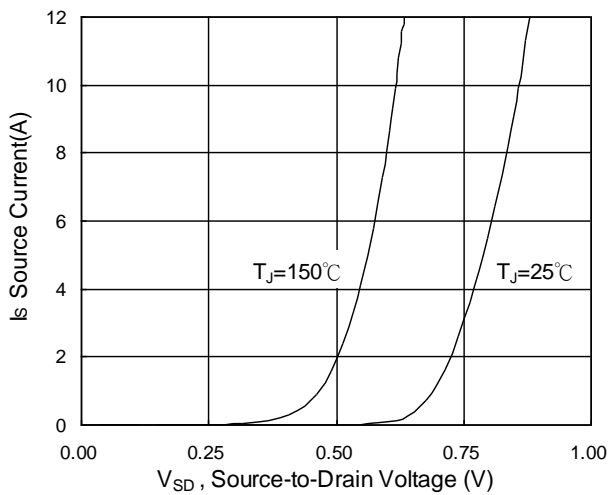


Fig.3 Forward Characteristics Of Reverse

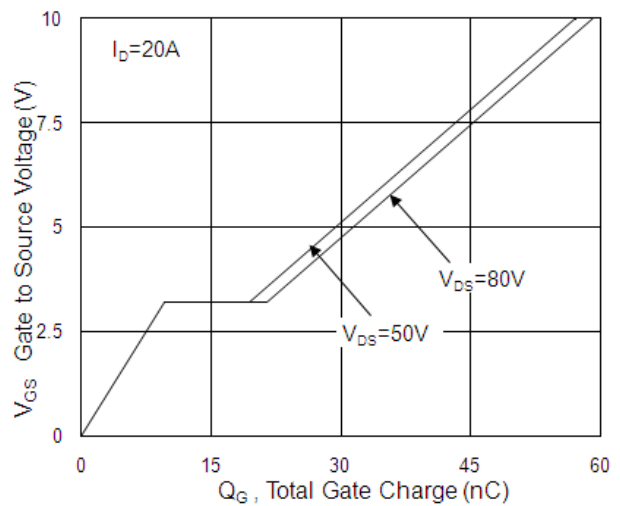


Fig.4 Gate-Charge Characteristics

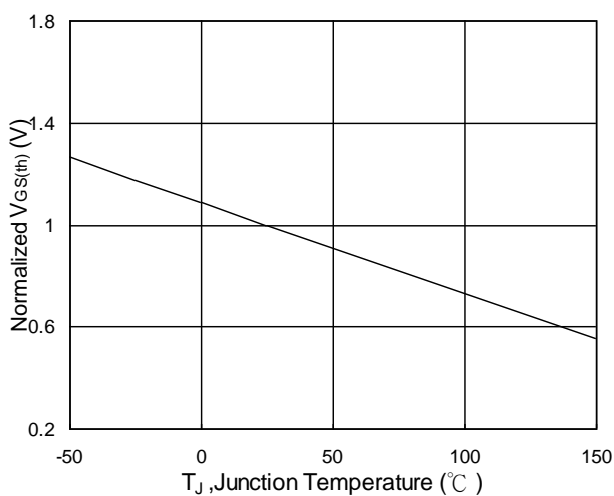


Fig.5 Normalized $V_{GS(th)}$ vs. T_J

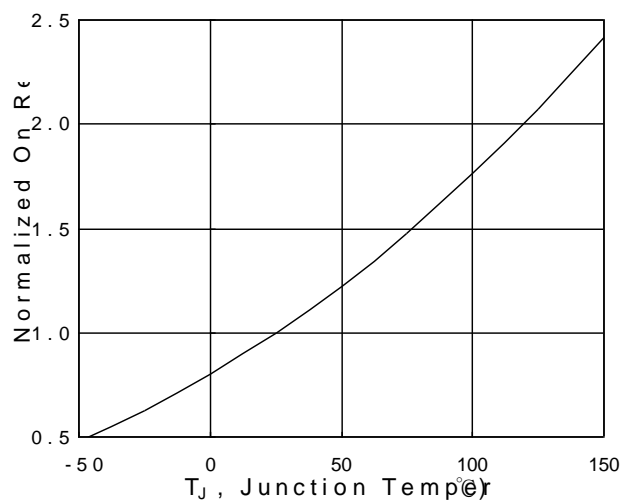


Fig.6 Normalized $R_{DS(on)}$ vs. T_J

100V N-Channel Enhancement Mode MOSFET

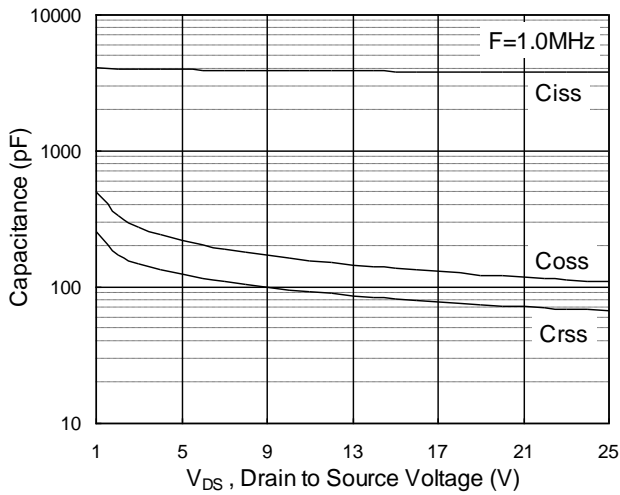


Fig.7 Capacitance

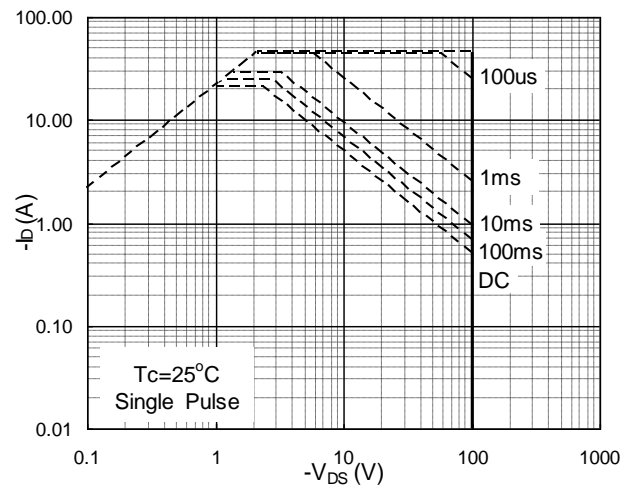


Fig.8 Safe Operating Area

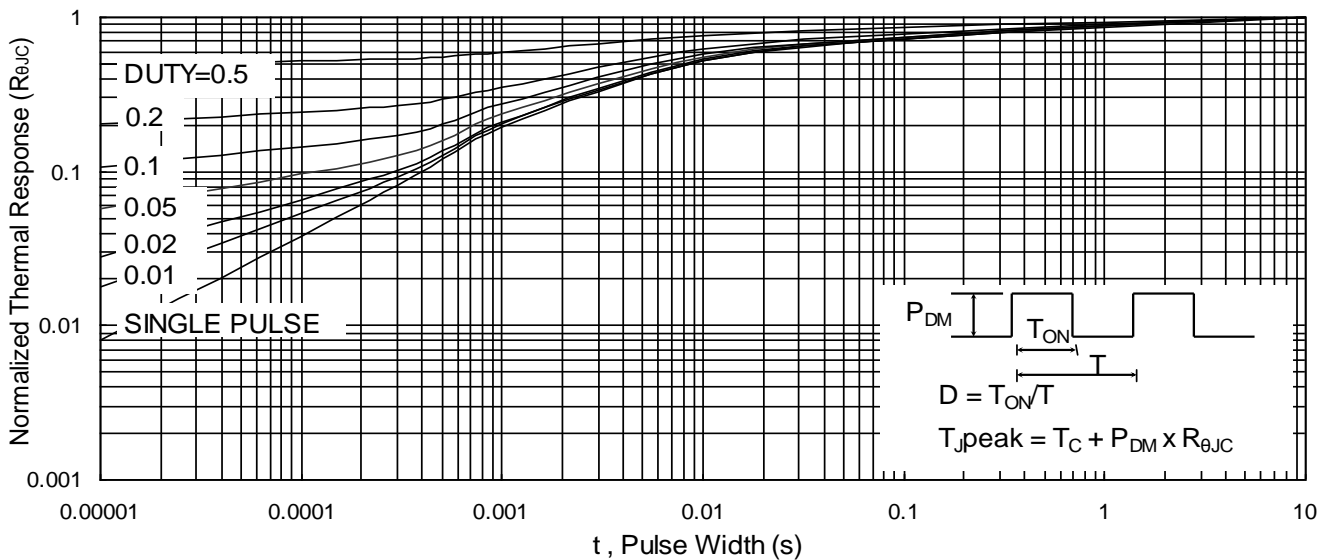


Fig.9 Normalized Maximum Transient Thermal Impedance

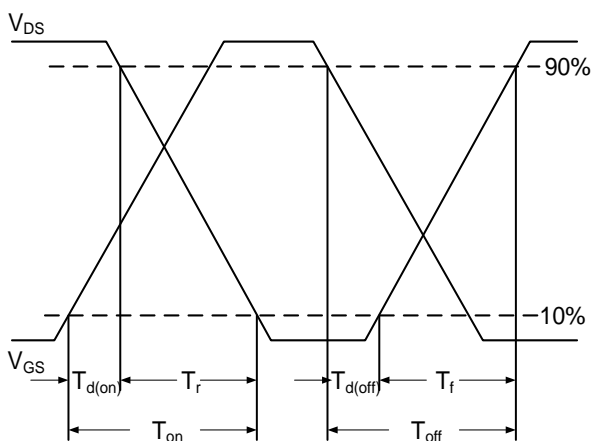


Fig.10 Switching Time Waveform

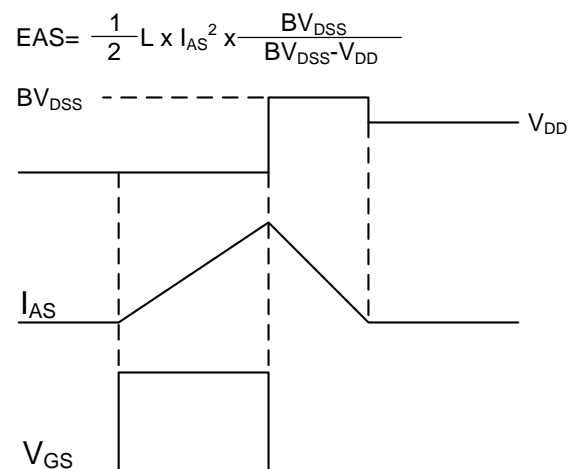
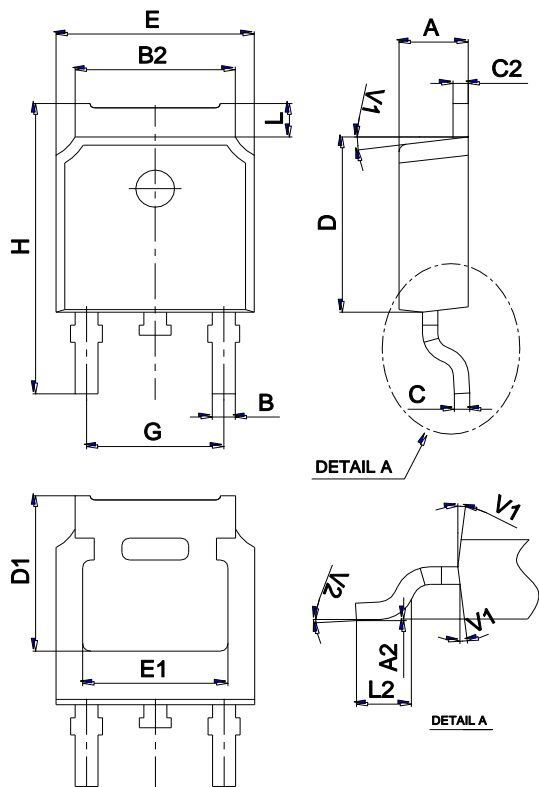


Fig.11 Unclamped Inductive Switching Waveform

Package Mechanical Data TO-252



| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|----------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.10 | | 2.50 | 0.083 | | 0.098 |
| A2 | 0 | | 0.10 | 0 | | 0.004 |
| B | 0.66 | | 0.86 | 0.026 | | 0.034 |
| B2 | 5.18 | | 5.48 | 0.202 | | 0.216 |
| C | 0.40 | | 0.60 | 0.016 | | 0.024 |
| C2 | 0.44 | | 0.58 | 0.017 | | 0.023 |
| D | 5.90 | | 6.30 | 0.232 | | 0.248 |
| D1 | 5.30REF | | | 0.209REF | | |
| E | 6.40 | | 6.80 | 0.252 | | 0.268 |
| E1 | 4.63 | | | 0.182 | | |
| G | 4.47 | | 4.67 | 0.176 | | 0.184 |
| H | 9.50 | | 10.70 | 0.374 | | 0.421 |
| L | 1.09 | | 1.21 | 0.043 | | 0.048 |
| L2 | 1.35 | | 1.65 | 0.053 | | 0.065 |
| V1 | | 7° | | | 7° | |
| V2 | 0° | | 6° | 0° | | 6° |

Ordering information

| Order code | Package | Baseqty | Delivery mode |
|----------------|---------|---------|---------------|
| UMW STD15NF10L | TO-252 | 2500 | Tape and reel |

单击下面可查看定价，库存，交付和生命周期等信息

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